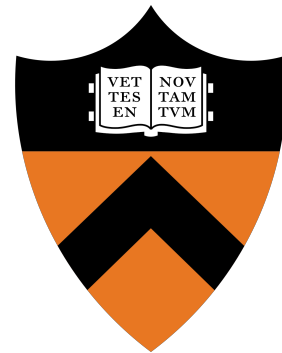


Impacts of Machine-learning in Future IC Design



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ML in IC design methodologies

- ML will be (is already) involved in IC design and design methodologies...

Today/Short-term

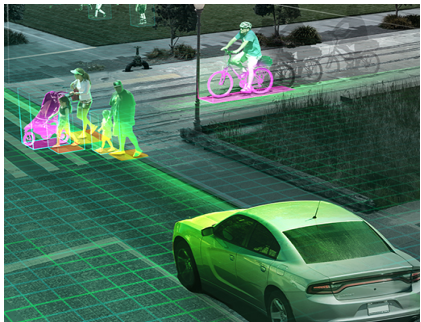
- Constraint solvers, non-linear optimization (placement, routing/pathfinding)
- Initial solutions, outlier detection (timing analysis, synthesis)

Future (?)

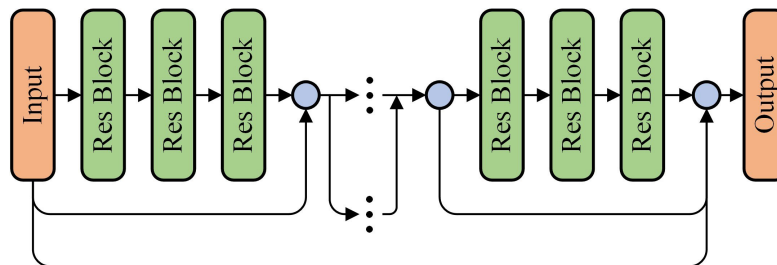
- Signal integrity analysis (parasitics + timing) [SLIP'15]
- Multi-physics analysis (temp + IR + glitching) [ASPDAC'16]

- ML is not magic, it is (data) science...

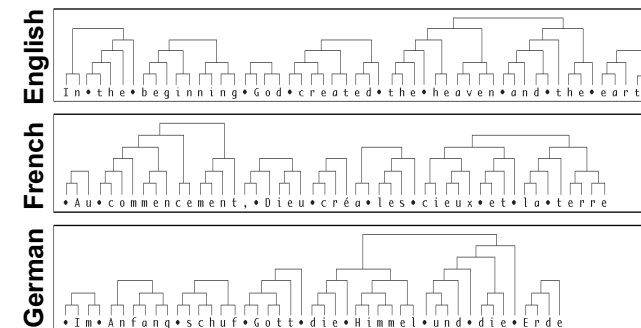
Vision: spatial encoding of semantics



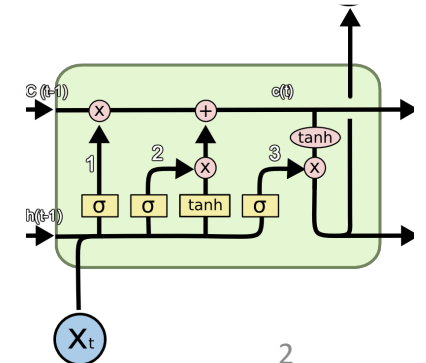
- Convolutional network:



Language: seq. encoding of semantics

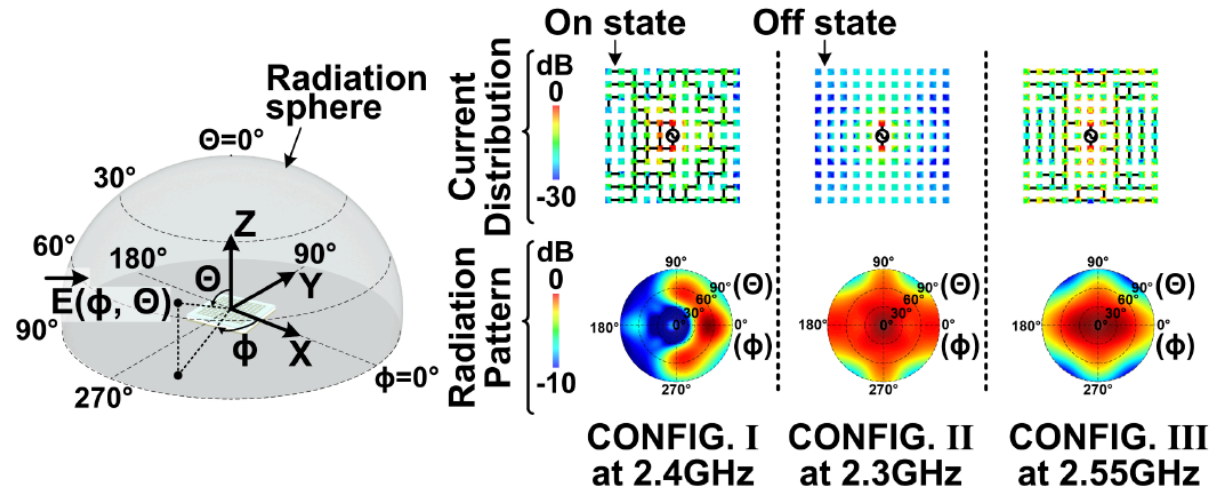
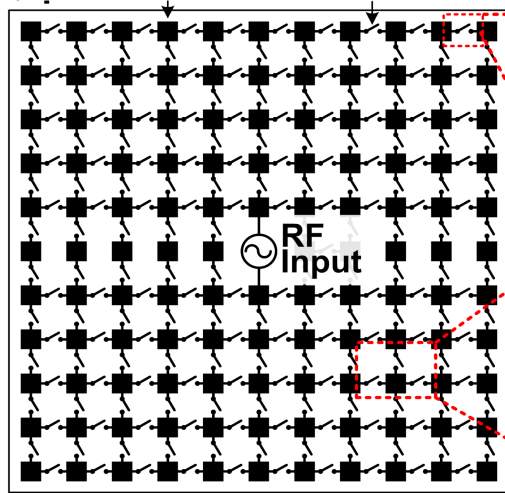


- LSTM network:

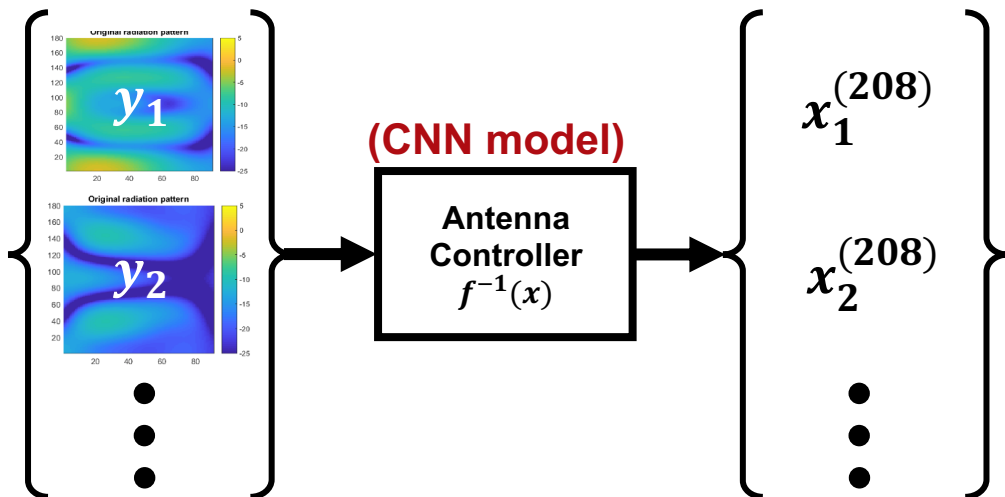


This will/should be a co-design process

- E.g., large-area reconfigurable antenna



- High-dimensional antenna control



Example Patterns from Controller

